

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	CHAN KYU PARK	05/23/2018
	SANG KYUNG AHN	05/23/2018
	YONG KU KIM	05/23/2018
	HYUN SUP NOH	05/23/2018
	EUN SEOK LEE	05/23/2018
	YOUNG KEE LEW	05/25/2018
	BYONG KAP JEON	05/25/2018
	JAE EUN JUNG	05/23/2018
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Name:	SAMSUNG C&T CORPORATION	
Street Address:	123, OLYMPIC-RO 35-GIL, SONGPA-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	05510	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	15993147
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ATTORNEY DOCKET NUMBER:	511544	
NAME OF SUBMITTER:	JOHN PAUL KALE	
SIGNATURE:	/John Paul Kale/	

DATE SIGNED:	05/30/2018
Total Attachments: 2 source=511544-Assignment#page1.tif source=511544-Assignment#page2.tif	

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ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS, WE, Chan Kyu Park, of #503-301, 31, Beonyeong-ro 200beon-gil, Gunpo-si, Gyeonggi-do 15874, Republic of Korea; Sang Kyung Ahn, of #101-1701, 37, Almata-gil, Dongjak-gu, Seoul 06939, Republic of Korea; Yong Ku Kim, of #110-1501, 174, Solsaem-ro, Gangbuk-gu, Seoul 01192, Republic of Korea; Hyun Sup Noh, of #208-104, 15, Gwangpyeong-ro 10-gil, Gangnam-gu, Seoul 06360, Republic of Korea; Eun Seok Lee, of #301, 38, Cheonhodaero 69-gil, Dongdaemun-gu, Seoul 02602, Republic of Korea; Young Kee Lew, of #101-102, 25, Samyang-ro 19-gil, Gangbuk-gu, Seoul 01200, Republic of Korea; Byung Kap Jeon, of #304-301, 30, Tancheonsang-ro, Suji-gu, Yongin-si, Gyeonggi-do 16866, Republic of Korea; and Jae Eun Jung, of #524-1001, 151, Naejeong-ro, Bundang-gu, Seongnam-si, Gyeonggi-do 13597, Republic of Korea, have invented and own a certain invention entitled:

HIGH-DAMPING RC LATTICE BEAM AND HIGH-DAMPING RC LATTICE BEAM STRUCTURE USING SAME

for which invention we have executed an application for Letters Patent of the United States, which was filed on May 30, 2018, under Application No. 15/993,147, and

WHEREAS, SAMSUNG C&T CORPORATION, of 123, Olympic-ro 35-gil, Songpa-gu, Seoul 05510, Republic of Korea (hereinafter referred to as Assignee), is desirous of acquiring the entire domestic and foreign right, title, and interest in and under the invention described in the application for Letters Patent.

NOW, THEREFORE, for good and valuable considerations, the receipt and sufficiency of which are hereby acknowledged, we assign and transfer to the Assignee and the Assignee's legal representatives, successors and assigns the full and exclusive rights in and to the invention in the United States and every foreign country and the entire right, title, and interest in and to the application for Letters Patent and other such applications (e.g., continuations, continuations-in-part, divisionals and reissues) that may be filed in the United States and every foreign country, and the Letters Patents or extensions thereof, both foreign and domestic, that may or shall issue thereon, and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue the Letters Patent in the United States to the above-mentioned Assignee agreeably with the terms of this assignment document.

WE HEREBY AUTHORIZE the Assignee to insert in this assignment document the filing date and serial number of the application if the date and number are unavailable at the time this document is executed.

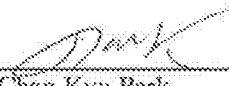
UPON SAID CONSIDERATION, we convey to the Assignee the right to make application in its own behalf for protection of the invention in countries foreign to the United States and to claim under the International Convention and/or other international arrangement for any such application the date of the United States application (or any other application if any there be) to gain priority with respect to other applications.

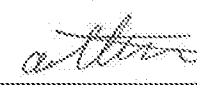
WE DO HEREBY COVENANT and agree with the Assignee that we will not execute any writing or do any act whatsoever conflicting with the terms of this assignment document set forth herein, and that we will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to perfect the Assignee's

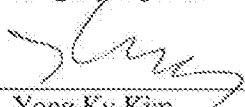
In re Appl. Of: Chan Kyu Park et al.
Attorney Docket No.: 511544

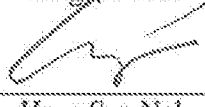
enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuation, renewal, reissued, or extended Letters Patent of the United States or of any and all foreign countries on the invention, and in enforcing any rights or chooses in action accruing as a result of such applications or patents, and by executing statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of all parties hereto. This Assignment may be executed in counterparts, each of which shall be deemed an original, but all of which together shall constitute one and the same instrument.

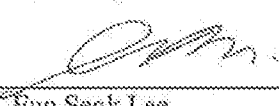
IN WITNESS WHEREOF, we have hereunder set our hands on the dates shown below.

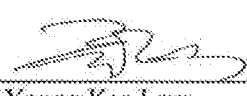
Date 2018/5/23 
Chan Kyu Park

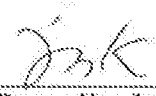
Date 2018/5/23 
Sang Kyang Ahn

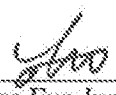
Date 2018/5/23 
Yong Ku Kim

Date 2018/5/23 
Hyun Sup Noh

Date 2018/5/23 
Eun Seok Lee

Date 2018/5/25 
Young Kee Lew

Date 2018/5/28 
Byong Kap Jeon

Date 2018/09/23 
Jae Eun Jung